



PJX8808

20V N-Channel Enhancement Mode MOSFET

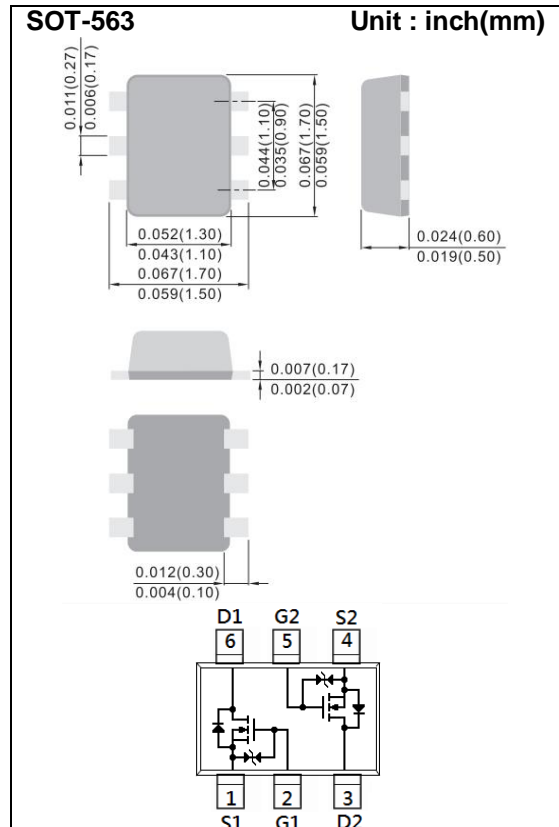
Voltage 20 V **Current** 500mA

Features

- Low Voltage Drive (1.2V).
- Advanced Trench Process Technology
- Specially Designed for Switch Load, PWM Application, etc.
- ESD Protected
- Lead free in compliance with EU RoHS 2011/65/EU directive.
- Green molding compound as per IEC61249 Std. (Halogen Free)

Mechanical Data

- Case: SOT-563 Package
- Terminals : Solderable per MIL-STD-750, Method 2026
- Approx. Weight: 0.00009 ounces, 0.0026 grams
- Marking: X08



Maximum Ratings and Thermal Characteristics ($T_A=25^{\circ}\text{C}$ unless otherwise noted)

PARAMETER	SYMBOL	LIMIT	UNITS	
Drain-Source Voltage	V_{DS}	20	V	
Gate-Source Voltage	V_{GS}	± 10	V	
Continuous Drain Current	I_D	500	mA	
Pulsed Drain Current	I_{DM}	1000	mA	
Power Dissipation	PD	$T_A=25^{\circ}\text{C}$	300	mW
		Derate above 25°C	2.8	mW/ $^{\circ}\text{C}$
Operating Junction and Storage Temperature Range	T_J, T_{STG}	-55~150	$^{\circ}\text{C}$	
Typical Thermal resistance	$R_{\theta JA}$	417	$^{\circ}\text{C}/\text{W}$	
- Junction to Ambient ^(Note 3)				



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Electrical Characteristics ($T_A=25^\circ\text{C}$ unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNITS
Static						
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{GS}=0V, I_D=250\mu A$	20	-	-	V
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	0.3	0.64	0.9	V
Drain-Source On-State Resistance	$R_{DS(on)}$	$V_{GS}=4.5V, I_D=500mA$	-	310	400	m Ω
		$V_{GS}=2.5V, I_D=200mA$	-	360	650	
		$V_{GS}=1.8V, I_D=100mA$	-	430	800	
		$V_{GS}=1.5V, I_D=50mA$	-	510	1200	
		$V_{GS}=1.2V, I_D=20mA$	-	710	3000	
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=16V, V_{GS}=0V$	-	-	1	μA
Gate-Source Leakage Current	I_{GSS}	$V_{GS}=\pm 8V, V_{DS}=0V$	-	± 0.5	± 10	μA
Dynamic (Note 5)						
Total Gate Charge	Q_g	$V_{DS}=10V, I_D=500mA,$ $V_{GS}=4.5V$ (Note 1,2)	-	1.4	-	nC
Gate-Source Charge	Q_{gs}		-	0.22	-	
Gate-Drain Charge	Q_{gd}		-	0.21	-	
Input Capacitance	C_{iss}	$V_{DS}=10V, V_{GS}=0V,$ $f=1.0MHz$	-	67	-	pF
Output Capacitance	C_{oss}		-	19	-	
Reverse Transfer Capacitance	C_{rss}		-	6	-	
Turn-On Delay Time	$t_{d(on)}$	$V_{DD}=10V, I_D=150mA,$ $V_{GS}=4.0V,$ $R_G=10\Omega$ (Note 1,2)	-	2.8	-	ns
Turn-On Rise Time	t_r		-	20	-	
Turn-Off Delay Time	$t_{d(off)}$		-	23	-	
Turn-Off Fall Time	t_f		-	23	-	
Drain-Source Diode						
Maximum Continuous Drain-Source Diode Forward Current	I_S	---	-	-	500	mA
Diode Forward Voltage	V_{SD}	$I_S=500mA, V_{GS}=0V$	-	0.87	1.3	V

NOTES :

1. Pulse width $\leq 300\mu s$, Duty cycle $\leq 2\%$
2. Essentially independent of operating temperature typical characteristics.
3. $R_{\theta JA}$ is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins mounted on a 1 inch FR-4 with 2oz. square pad of copper.
4. The maximum current rating is package limited.
5. Guaranteed by design, not subject to production testing.



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TYPICAL CHARACTERISTIC CURVES

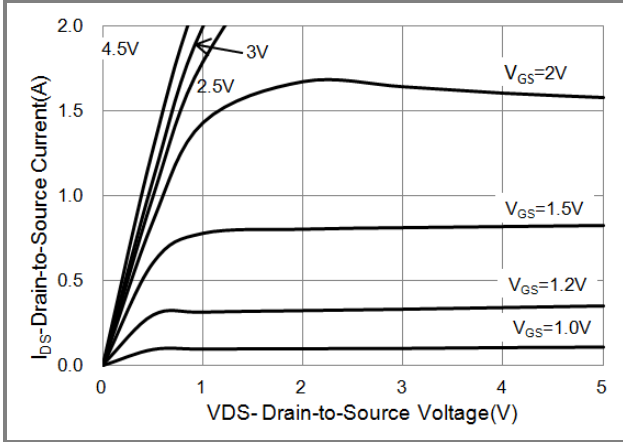


Fig.1 On-Region Characteristics

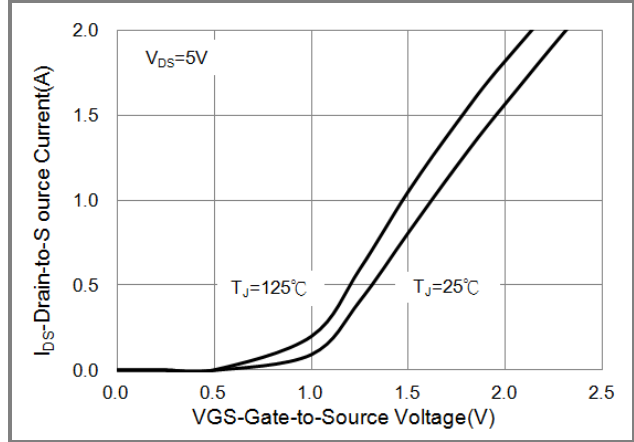


Fig.2 Transfer Characteristics

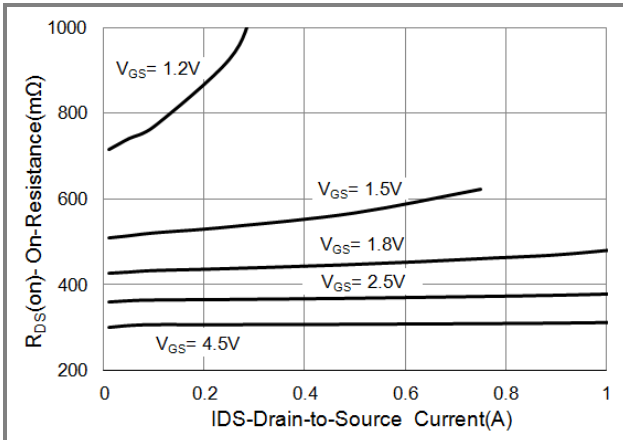


Fig.3 On-Resistance vs. Drain Current

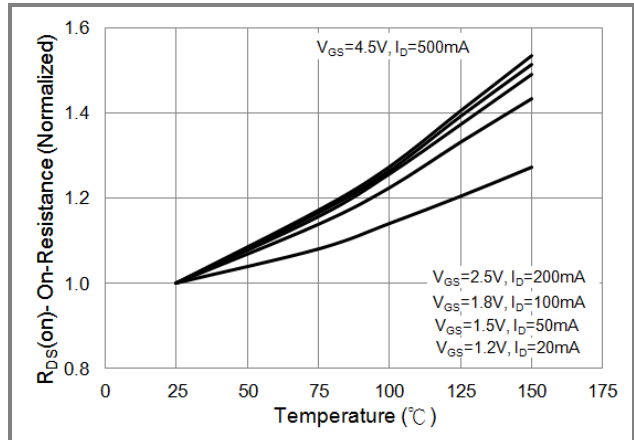


Fig.4 On-Resistance vs. Junction temperature

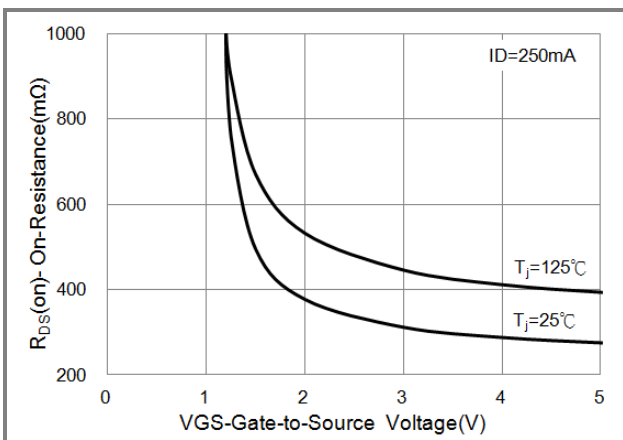


Fig.5 On-Resistance Variation with VGS.

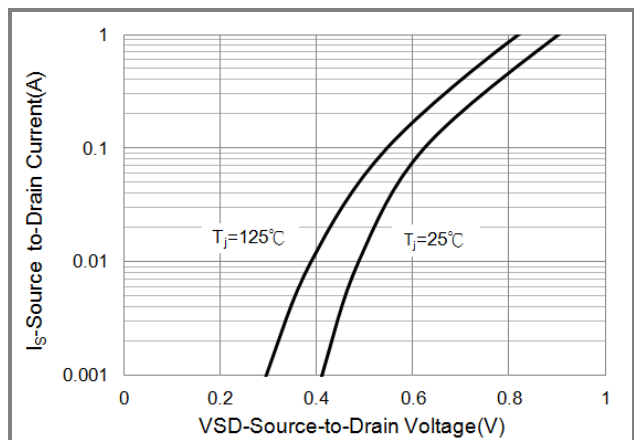


Fig.6 Body Diode Characteristics



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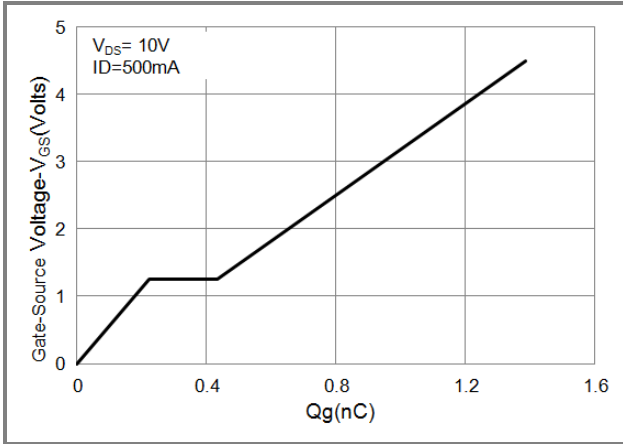


Fig.7 Gate-Charge Characteristics

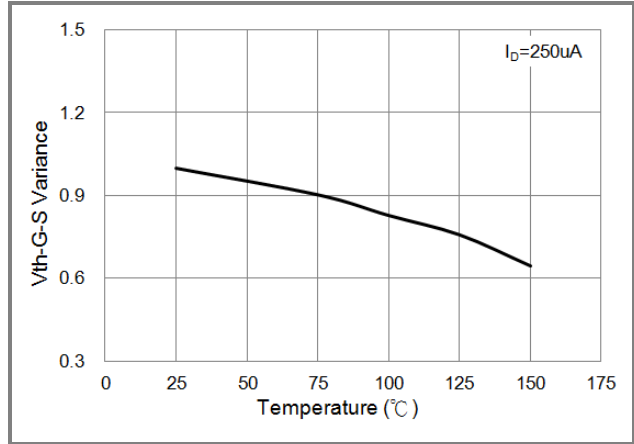


Fig.8 Breakdown Voltage Variation vs. Temperature

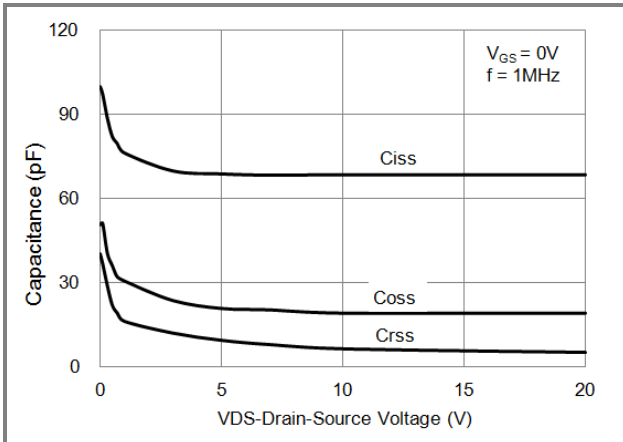


Fig.9 Threshold Voltage Variation with Temperature

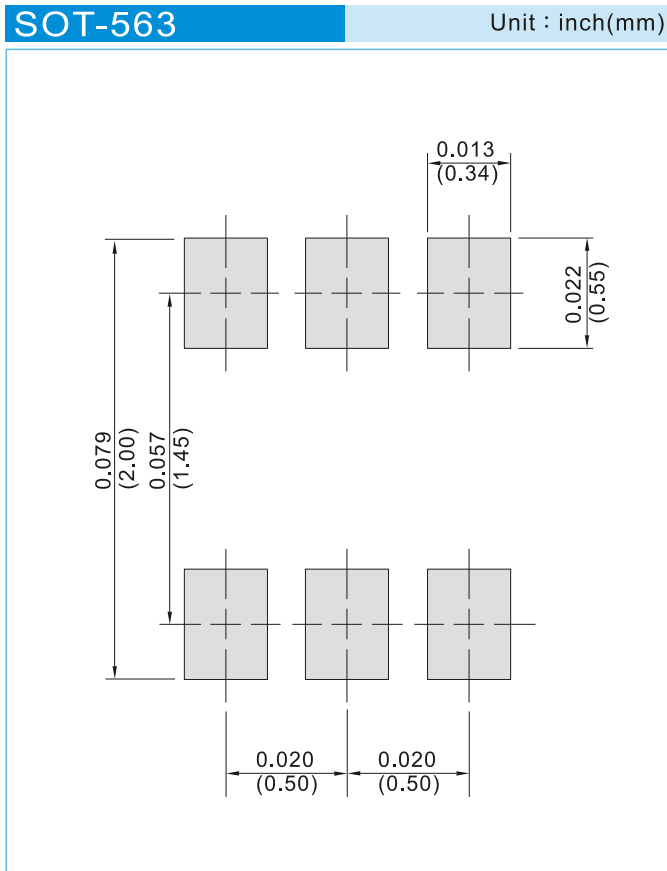


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PART NO PACKING CODE VERSION

PART NO PACKING CODE	Package Type	Packing type	Marking	Version
PJX8808_R1_00002	SOT-563	8K pcs / 7" reel	X08	Halogen free
PJX8808_R2_00002	SOT-563	20K pcs / 13" reel	X08	Halogen free

MOUNTING PAD LAYOUT





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